

Avalanche Photodiodes :

A User's Guide

by EG&G Optoelectronics Canada

Abstract-Avalanche photodiode detectors have and will continue to be used in many diverse applications such as laser range finders and photon correlation studies. This paper discusses APD structures, critical performance parameters and the excess noise factor.

1. Introduction

For low-light detection in the 200 to 1150-nm range, the designer has three basic detector choices - the silicon PIN detector, the silicon avalanche photodiode (APD) and the photomultiplier tube (PMT).

APDs are widely used in instrumentation and aerospace applications, offering a combination of high speed and high sensitivity unmatched by PIN detectors, and quantum efficiencies at >400 nm unmatched by PMTs.

Recently demonstrated performance includes:

- Noise equivalent power (NEP) of $<10^{-15}$ W/Hz^{1/2} for a 0.5 mm APD.
- Detection of 100-photon, 20-ns pulses with standard APDs.
- Detection of 10-photon, 20-ns pulses with special APDs.
- BER data communications at 810 nm at 60Mb/s with only 39 photons/bit.
- Photon-counting detection efficiencies >70 percent at 633nm; dark counts of only 1 count/s on 150- μ m-diameter APDs.
- Detection and resolution of low energy, 1 to 30 keV X-rays.

2. What is an Avalanche Photodiode ?

2.1 APD Structures

In order to understand why more than one APD structure exists, it is important to appreciate the design trade-offs that must be accommodated by the APD designer. The ideal APD would have zero dark noise, no excess noise, broad spectral and frequency response, a gain range from 1 to 10⁶ or more, and low cost. More simply, an ideal APD would be a good PIN photodiode with gain! In reality however, this is difficult to achieve because of the need to trade-off conflicting design requirements. What some of these trade-offs are, and how they are optimized in commercially available APDs, are listed below.

Consider the schematic cross-section for a typical APD structure shown in Figure 1. The basic structural elements provided by the APD designer include an absorption region "A", and a multiplication region, "M". Present across region "A" is an electric field "E" that serves to separate the photo-generated holes and electrons, and sweeps one carrier towards the multiplication region. The multiplication region "M" is designed to exhibit a high electric field so as to provide

internal photo-current gain by impact ionization. This gain region must be broad enough to provide a useful gain, M , of at least 100 for silicon APDs, or 10-40 for germanium or InGaAs APDs. In addition, the multiplying electric field profile must enable effective gain to be achieved at a field strength below the breakdown field of the diode.

Figure 1 shows the "reach-through" structure patented by EG&G which offers the best available combination of high speed, low noise and capacitance, and extended red response.

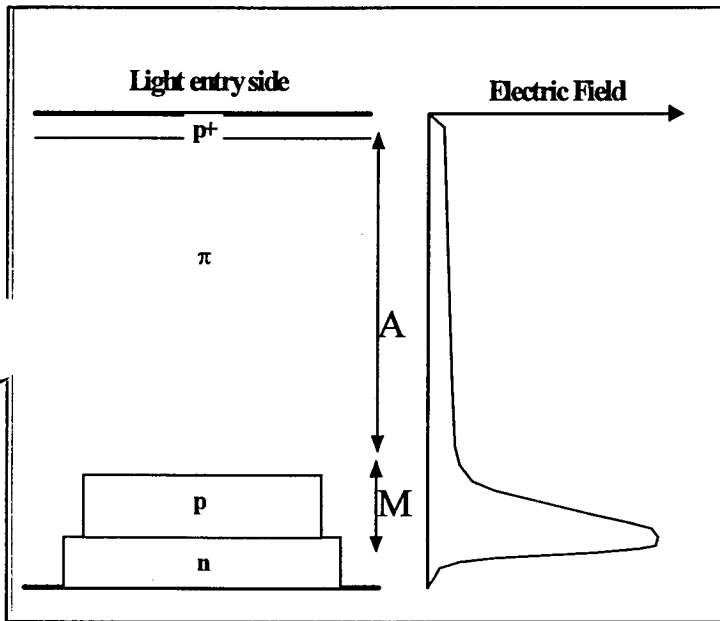


Figure 1: Reach-through APD Structure.

(Not to scale)

2.2 Critical Performance Parameters

An APD differs from a PIN photodiode by providing internal photo-electronic signal gain. Therefore, output signal current, I_S , from an APD equals $I_S = MR_o(\lambda)P_S$, where $R_o(\lambda)$ is the intrinsic responsivity of the APD at a gain $M=1$ and wavelength λ , M is the gain of the APD, and P_S is the incident optical power. The gain is a function of the APDs reverse voltage, V_R , and will vary

with applied bias. A typical gain-voltage curve for a silicon APD manufactured by EG&G is shown in Figure 2.

One of the key parameters to consider when selecting an APD is the detector's spectral noise. Like other detectors, an APD will normally be operating in one of two noise-limited detection regimes; either detector noise limited at low power levels, or photon shot noise limited at higher powers. As an APD is designed to be operated under a reverse bias, sensitivity at low light levels will be limited by the shot noise and the APDs leakage current. Shot noise derives from the random statistical Poissonian fluctuations of the dark current, I_D (or signal current). Dark current shot noise $I_{N(SHOT)}$ is normally given by $I_{N(SHOT)} = (2qBI_D)^{1/2}$ for a PIN detector, where B is the system bandwidth. This differs for an APD however, as bulk leakage current, I_{DB} , is multiplied by the gain, M , of the APD⁽⁴⁾. Total leakage current I_D is therefore equal to:

$$I_D = I_{DS} + I_{DB}M$$

Where I_{DS} is the surface leakage current.

In addition, the avalanche process statistics generate current fluctuations, and APD performance is degraded by an "excess noise factor" (F) compared to a PIN. A detailed explanation and calculation of the excess noise factor, F , is given in section 4. The total spectral noise current for an APD in "dark" conditions is thus given by:

$$i_N = [2q(I_{DS} + I_{DB}M^2F)B]^{1/2}$$

Where q is the electron charge.

At higher signal light levels, the detector transitions to the photon shot noise limited regime where sensitivity is limited by photon shot noise on the current generated by the optical signal. Total noise from the APD in "illuminated" conditions will therefore equal the quadratic sum of the detector noise plus the signal shot noise. For

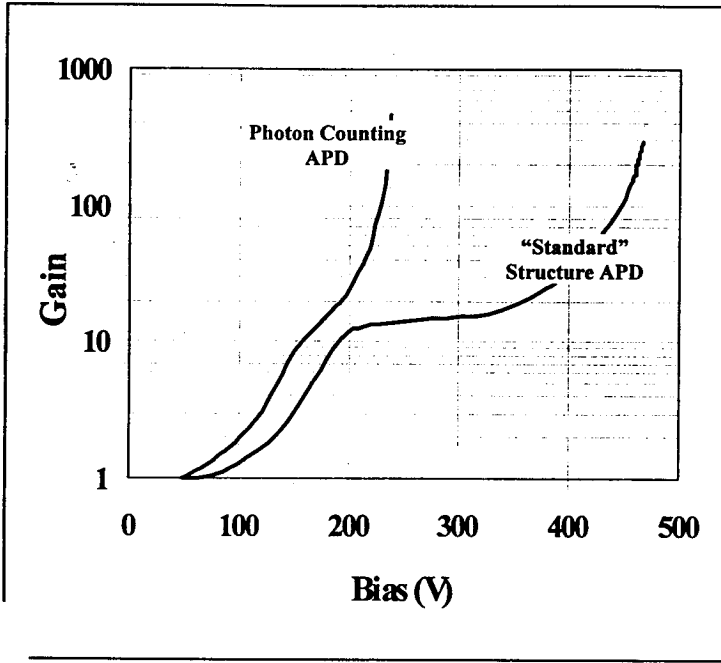


Figure 2: Typical gain-voltage curve for Si APDs.

a given optical signal power, P_s , this is given by:

$$i_{N(Total)} = \left[2q(I_{DS} + (I_{DB} M^2 + R_0(\lambda) M^2 P_s) F) B \right]^{1/2}$$

In the absence of other noise sources, an APD therefore provides a signal-to-noise ratio (SNR) which is \sqrt{F} worse than a PIN detector with the same quantum efficiency. An APD, however, can produce a better overall system signal-to-noise ratio than a PIN detector in cases where the APD internal gain boosts the signal level without dramatically affecting the overall system noise.

Noise equivalent power (NEP) cannot be used as the only measure of a detector's relative performance, but

rather detector signal-to-noise (SNR) at a specific wavelength and bandwidth should be used to determine the optimum detector type for a given application. Note that optimum signal-to-noise occurs at a gain M where total detector noise equals the input noise of the amplifier or load resistor. The optimum gain depends in part on the excess noise factor, F , of the APD, and ranges from $M=100$ to 1000 for silicon APDs, and is limited to $M=30$ to 40 for germanium and InGaAs APDs.

3. Selecting an APD

3.1 Specifying your requirement

APDs are generally recommended for high bandwidth applications or where internal gain is needed to overcome high pre-amp noise. The following is a simple guide that can be used to decide whether an APD is the most appropriate for one's light detection requirements.

- 1) Determine the wavelength range to be covered. See section 3.2 below to determine the specific APD type useful for the wavelength range to be covered.
- 2) Determine the minimum size of the detector that can be used in the optical system. Effective optics can often be more cost-effective than the use of an overly large PIN or Avalanche photodetector.
- 3) Determine the required electrical frequency bandwidth of the system; again, over-specifying bandwidth will degrade the SNR of the system.

3.2 Types of APDs

Avalanche photodiodes are commercially available that span the wavelength range from 300nm to 1700nm.

Silicon APDs can be used between 300nm to 1100nm, germanium between 800nm and 1600nm, and InGaAs from 900nm to 1700nm.

Although significantly more expensive than germanium APDs, InGaAs APDs are typically available with significantly lower noise currents, exhibit extended spectral response to 1700nm, and provide higher frequency bandwidth for a given active area. A germanium APD is recommended for environments applications in high electro-magnetic interference (EMI), where amplifier noise is significantly higher than the noise from an InGaAs APD, or for applications where cost is of primordial consideration.

3.3 Understanding the Specifications

It is important to understand several performance metrics when selecting an APD appropriate for one's application. Listed below are some of the most important specifications, and an explanation as to how different manufacturer's listings should be compared.

Responsivity and Gain: APD gain will vary as a function of applied reverse voltage, as shown in Figure 2. In addition, for many APDs, it is not possible, or practical, to make an accurate measurement of the intrinsic responsivity, $R_o(\lambda)$, at a gain $M=1$. It is therefore inappropriate to state typical gain and diode sensitivity at $M=1$ as a method for specifying diode responsivity at a given operating voltage. In order to characterize APD response, one must specify APD responsivity (in Amps/Watt) at a given operating voltage.

However, because of diode to diode variations in the exact gain-voltage curve of each APD, the specific operating voltage for a given responsivity will vary from

one APD to another. Manufacturers should therefore specify a voltage range within which a specific responsivity will be achieved. An example of a typically correct specification for diode responsivity, in this case for an InGaAs APD, is as follows:

$$R_{\text{MIN}}(1300\text{nm})=9.0\text{A/W}, V_{\text{OP}}=50\text{V to }90\text{V}, M\geq 10.$$

Dark Current and Noise Current: As can be seen from the noise equation in section 2.2, total APD dark current (and corresponding spectral noise current) is only meaningful when specified at a given operating gain. Dark current at $M=1$ is dominated by surface current, and may be significantly less than $I_{\text{DB}} \times M$. Since APD dark and spectral noise current are a strong function of APD gain, these should be specified at a stated responsivity level. An example of a typically correct specification for diode dark current and noise current, in this case for an InGaAs APD, is as follows:

$$I_{\text{D}}(R=9.0\text{A/W})=10\text{nA (max)}, M\geq 10$$

$$i_{\text{N}}(R=6.0\text{A/W}, 1\text{MHz}, 1\text{Hz BW})=0.8 \text{ pA}/\sqrt{\text{Hz}} \text{ (max)}, M>5$$

4. Excess Noise Factor

All avalanche photodiodes generate excess noise due to the statistical nature of the avalanche process. The 'Excess Noise Factor is generally denoted as 'F'. As shown in the noise equation (section 2.2), \sqrt{F} is the factor by which the statistical noise on the APD current (equal to the sum of the multiplied photocurrent plus the multiplied APD bulk dark current) exceeds that which would be expected from a noiseless multiplier on the basis of Poissonian statistics (shot noise) alone.

The excess noise factor is a function of the carrier ionization ratio, k , where k is usually defined as the ratio of hole to electron ionization probabilities ($k\leq 1$). The excess noise factor may be calculated using the model developed by McIntyre⁽³⁾ which considers the statistical

nature of avalanche multiplication. The excess noise factor is given by:

$$F = k_{EFF} M + (1 - k_{EFF}) \left(2 - \frac{1}{M} \right)$$

Therefore, the lower the values of k and M, the lower the excess noise factor. The effective k-factor, k_{EFF} , for an APD can be measured experimentally by fitting the McIntyre formula to the measured dependence of the excess noise factor on gain. This is best done under illuminated conditions. It may also be theoretically

the longer wavelengths, and the 'mean' absorption depth is therefore a function of wavelength. The value of k_{EFF} , and gain, M, for a silicon APD is thus a function of wavelength for some doping profiles.

The McIntyre formula can be approximated for a $k < 0.1$ and $M > 20$ without significant loss of accuracy as:

$$F = 2 + kM$$

Table1: Typical values of k, X and F for Si, Ge and InGaAs

Detector Type	Ionization Ratio (k)	X-Factor	Typical Gain (M)	Excess Noise Factor (F)
Silicon ("reach-through" structure)	0.02	—	150	4.9
Silicon ("SLiK™ low-k structure)	0.002	—	500	3.0
Germanium	0.9	0.95	10	9.2
InGaAs	0.45	0.7- 0.75	10	5.5

calculated from the carrier ionization coefficients and the electric field profile of the APD structure.

The ionization ratio k is a strong function of the electric field across the APD structure, and takes its lowest value at low electric fields (only in Silicon). Since the electric field profile depends upon the doping profile, the k factor is also a function of the doping profile. Depending on the APD structure, the electric field profile traversed by a photo-generated carrier and subsequent avalanche-ionized carriers may therefore vary according to photon absorption depth. For indirect bandgap semiconductors such as silicon, the absorption coefficient varies slowly at

Also often quoted by APD manufacturers is an empirical formula used to calculate the excess noise factor, given as:

$$F = MX$$

where the value of X is derived as a log-normal linear fit of measured F-values for given values of gain M. This approximation is sufficiently good for many applications, particularly when used with APDs with a high k factor, such as InGaAs and Germanium APDs.

Table 1. provides typical values of k, X, and F for silicon, germanium and InGaAs APDs. With the exception of Super-Low k (SLiK™) APDs used in photon counting

modules, all EG&G silicon APDs have $k=0.02$. Note that for germanium and InGaAs, a k -value is generally quoted at $M=10$, which somewhat overestimates F at $M<10$ and underestimates F at $M>10$.

5. Geiger Mode:

In the Geiger mode^{(2),(4)}, an APD is biased above its breakdown voltage ($V_R > V_{BR}$) for operation at very high gain (typically 10^5 to 10^6). When biased above breakdown, an APD will normally conduct a large current. However, if this current is limited to less than the APD's "latching" current, there is a strong statistical probability that the current will fluctuate to zero in the multiplication region, and the APD will then remain in the "off" state until an avalanche pulse is triggered by either a bulk or photo-generated carrier. If the number of bulk carrier generated pulses is low, the APD can therefore be used to count individual current pulses from incident photons. The value of the bulk dark current is therefore a significant parameter in selecting an APD for photon-counting, and can be reduced exponentially by cooling.

To date, only silicon APDs have bulk dark currents low enough to be suitable for use in commercially available single photon-counting modules (SPCMs), although photon-counting has been demonstrated experimentally with germanium and InGaAs APDs⁽¹⁾. Dark counts as low as <1 cps (counts per second) have been reported for EG&G SLiK™ silicon APDs cooled to -20 C, and counts of <250 cps are typically achievable with a cooled 0.5mm C30902S APD.

6. Applications:

In both modes of APD operation, ie. Linear and Geiger, APDs have and will continue to be used in many diverse applications. In the linear mode operation, the APD is well suited for applications which require high sensitivity and fast response times. For example, laser range finders which incorporate APD detectors result in more

sensitive instruments than ones which use conventional PIN detectors. In addition, APDs used in this application can operate with lower light levels and shorter laser pulses, thus making the range finder more 'eye safe'.

Other applications for APDs include fast receiver modules, confocal microscopy and particle detection. A silicon APD can be used in applications to detect Alpha particles, electrons with energies as high as 150KeV, and other forms of radiation.

Silicon APDs operated in the Geiger mode are used to detect single photons for photon correlation studies and are capable of achieving very short (20-50ps) resolving times. Operated in this mode, EG&G's SLiK™ detector provide gains of up to 10^8 and quantum efficiencies of approximately 70% at 633nm and 50% at 830nm. Other applications in which APDs operated in this mode are used include: Lidar, Astronomical observations, Optical range finding, Optical fiber test and fault location, Ultrasensitive fluorescence, etc.

References:

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